



Connectors > Terminal Blocks & Strips > Barrier Strips



Number of Positions: 16

Barrier Strip Style: Tri-Barrier

Bottom Termination Type: Printed Circuit Pin

Connector System: Wire-to-Board

Centerline (Pitch): 9.53 mm [.375 in]

Features

Product Type Features

Block Style	Flat Bottom with standoffs
Connector System	Wire-to-Board
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Levels	1
Number of Positions	16
Number of Rows	1

Electrical Characteristics

Operating Voltage	300 V, 600 V
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Body Features

Primary Product Color	Black
Product Orientation	Vertical
Barrier Strip Style	Tri-Barrier

Contact Features

Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Tin
Contact Current Rating (Max)	5 A, 25 A

Termination Features



Bottom Termination Type	Printed Circuit Pin
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Mechanical Attachment

Top Termination Type	Binding Combo Head
Mounting Options	None
Screw Plating Material	Zinc Chromate
Thread Size	6-32
Screw Material	Steel
Screw Head Type	Combo Phil-Slot
Connector Mounting Type	Board Mount

Housing Features

Housing Material	Thermoplastic
Centerline (Pitch)	9.53 mm[.375 in]

Dimensions

Product Length	153.95 mm[6.061 in]
Wire Size	22 – 12 AWG

Operation/Application

Circuit Application	Power
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Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Method	Package
Packaging Quantity	60

Product Compliance

For compliance documentation, visit the product page on [TE.com](#)>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JUL 2021 (219) Does not contain REACH SVHC



Halogen Content	Not Yet Reviewed for halogen content
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) ‘Guidance on requirements for substances in articles’ posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Also in the Series | BUCHANAN 6 Series

Barrier Strips(149)

Customers Also Bought

TE Part #1-1393243-0
RTE24024

TE Part #3-1393222-9
V23061A1007A302=MINISTARKSTROM

Documents

Product Drawings

6PCV-16-007=6 SERIES ASSY

English

CAD Files

Customer View Model

ENG_CVM_CVM_8-1437653-1_P.3d_igs.zip

English

Customer View Model



[ENG_CVM_CVM_8-1437653-1_P.3d_stp.zip](#)

English

Customer View Model

[ENG_CVM_CVM_8-1437653-1_P.2d_dxf.zip](#)

English

[3D PDF](#)

3D

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Datasheets & Catalog Pages

[1-1773458-2_BARRIER_STRIPS_QUICK_REFERENCE_GUIDE](#)

English

Agency Approvals

[UL](#)

English